

Commercial Lines



AGC Taconic Multimaterial
• PTFE/Woven Glass Laminates for Microwave, RF and High Speed Digital Applications



Magnachip
• Discrete IGBT's • LV MOSFET
• HV MOSFET • SJ MOSFET



AMPLEON - Formerly NXP
• LDMOS Transistors and GaN Devices up to 6GHz and 1900W



Nanya
• Standard DRAM
• Low Power DRAM
• MCP • KGD



APAT
• SFP • SFP+ • QSFP+
• XFP • GPON • BOSA



NeoPhotonics
Components for 100G and beyond:
• Coherent Modules & Components
• Client Transceivers
• Optical Switching
• Passive Components



EDAC
Connectors for Signal and Power:
• Wire to Board • Board to Board
• Wire to Wire • Custom Solutions



Semtech Corporation 
• Wireless Connectivity Solutions
• Power Management
• Protection • Power Discretes



Flex - Power Modules
• Isolated DC/DC Converters
• Non-isolated PoL Converters



Silicon Labs
• IoT - Node to Cloud Solutions
• MCU (8 and 32 bits)
• Wireless (WIFI, Bluetooth, ZigBee, Thread and Sub-GHz)
• Sensors



Johanson Dielectrics
• Surface Mount & Planar Array Capacitors • Leaded Capacitors
• Precision Resistors
• Power Inductors



Wolfspeed
• Discrete SiC MOSFETs and Schottky Diodes
• Bare Die SiC MOSFETs and Schottky Diodes
• SiC Power Modules
• Gate Driver Boards



Johanson Technology
• Antennas • RF Capacitors
• Integrated Passives & Chipset Specific RF Front-End